

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Not recommended
for new design

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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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2SK2734

Silicon N Channel MOS FET
High Speed Power Switching

RENESAS

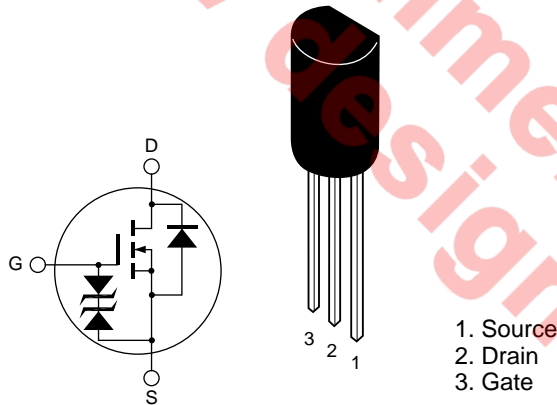
ADE-208-520 (Z)
1st. Edition
Jun 1997

Features

- Low on-resistance
 $R_{DS(on)} = 0.04\Omega$ typ (at $V_{GS} = 10\text{ V}$, $I_D = 2.5\text{ A}$)
- 4V gate drive devices.
- Large current capacitance
 $I_D = 5\text{ A}$

Outline

TO-92MOD.



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	5	A
Drain peak current	I _{D(pulse)} *1	20	A
Body to drain diode reverse drain current	I _{DR}	5	A
Channel dissipation	Pch	0.9	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

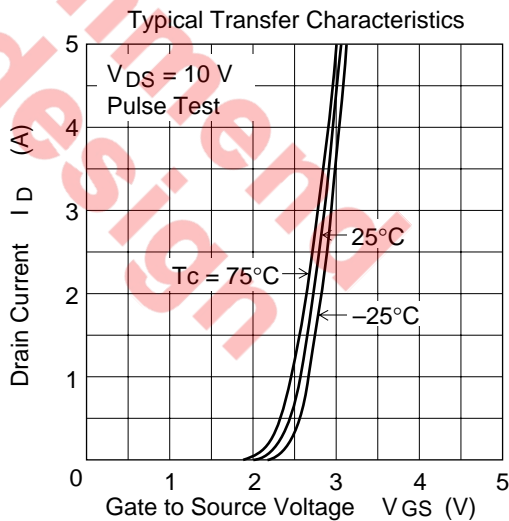
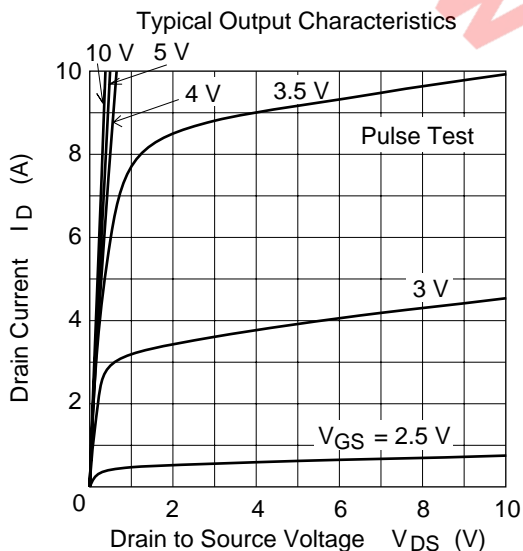
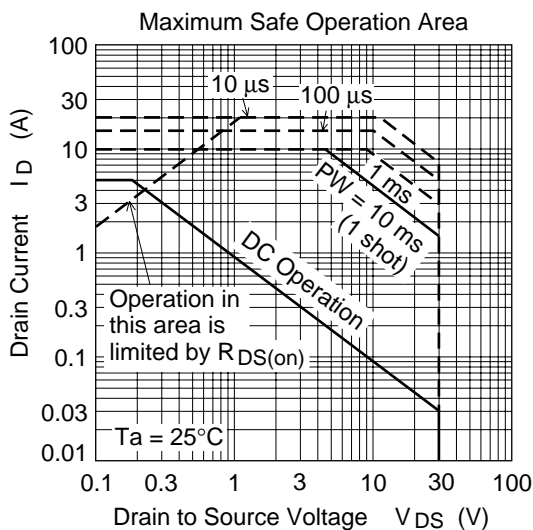
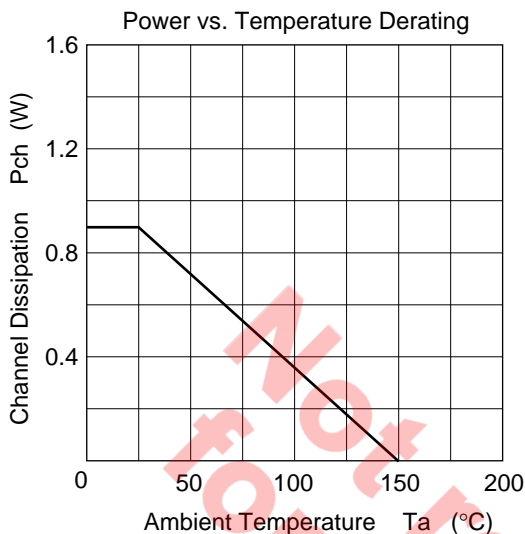
Note: 1. PW ≤ 10μs, duty cycle ≤ 1 %

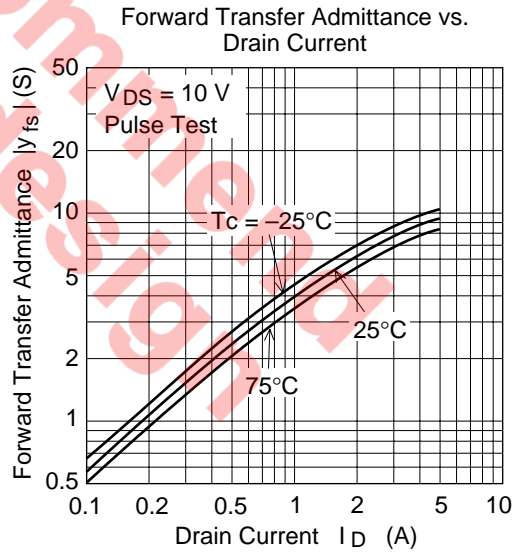
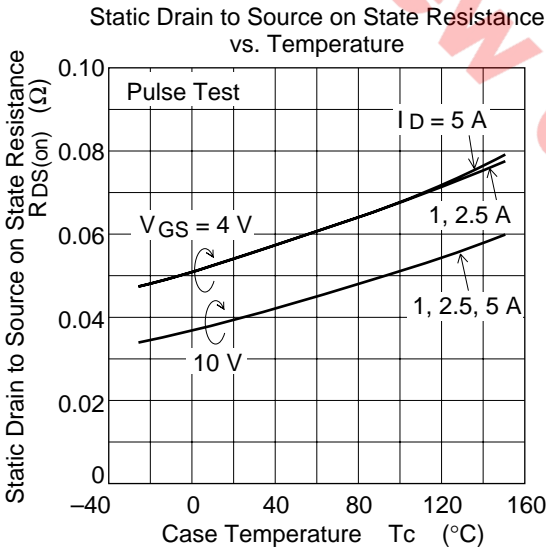
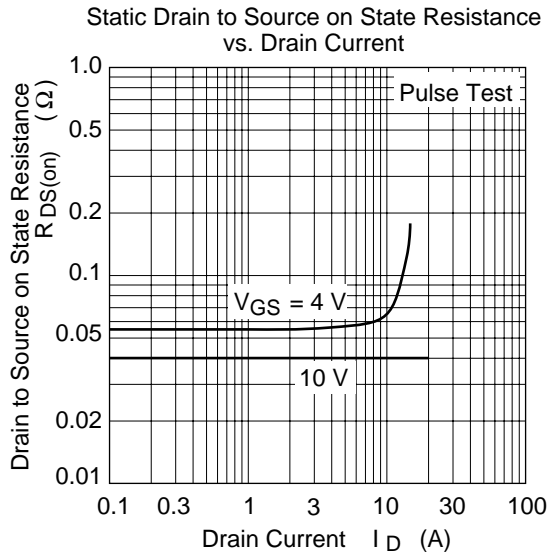
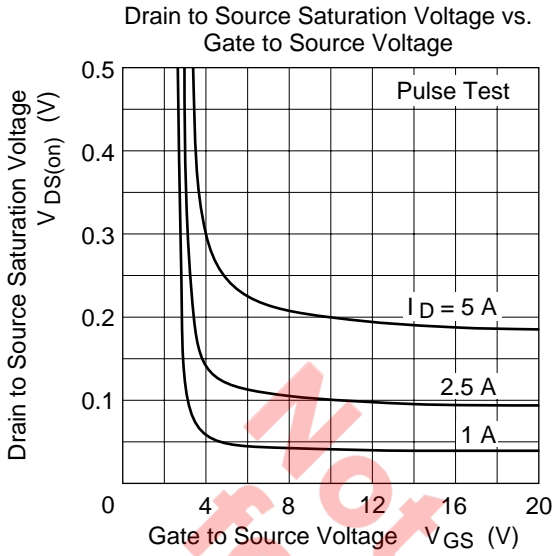
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	—	—	V	I _D = 10mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	—	V	I _G = ±100μA, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	10	μA	V _{DS} = 30 V, V _{GS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	μA	V _{GS} = ±16V, V _{DS} = 0
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.0	V	I _D = 1mA, V _{DS} = 10V
Static drain to source on state resistance	R _{DS(on)}	—	0.04	0.055	Ω	I _D = 2.5A, V _{GS} = 10V*1
	R _{DS(on)}	—	0.055	0.08	Ω	I _D = 2.5A, V _{GS} = 4V*1
Forward transfer admittance	y _{fs}	4	7	—	S	I _D = 2.5A, V _{DS} = 10V*1
Input capacitance	Ciss	—	550	—	pF	V _{DS} = 10V
Output capacitance	Coss	—	380	—	pF	V _{GS} = 0
Reverse transfer capacitance	Crss	—	155	—	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	—	14	—	ns	V _{GS} = 10V, I _D = 2.5A
Rise time	t _r	—	80	—	ns	R _L = 4Ω
Turn-off delay time	t _{d(off)}	—	80	—	ns	
Fall time	t _f	—	65	—	ns	
Body to drain diode forward voltage	V _{DF}	—	1.0	—	V	I _F = 5A, V _{GS} = 0
Body to drain diode reverse recovery time	t _{rr}	—	40	—	ns	I _F = 5A, V _{GS} = 0 di _F / dt = 50A/μs

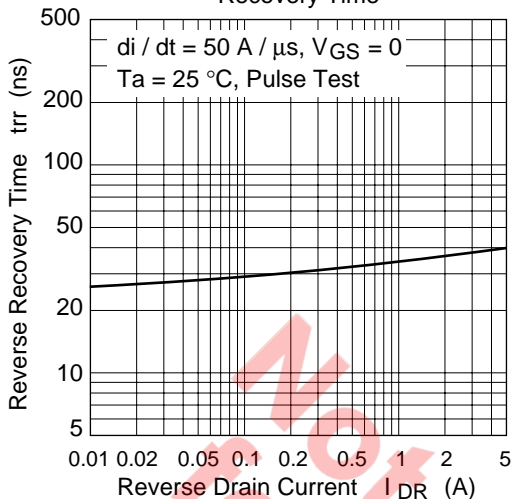
Note: 1. Pulse test

Main Characteristics

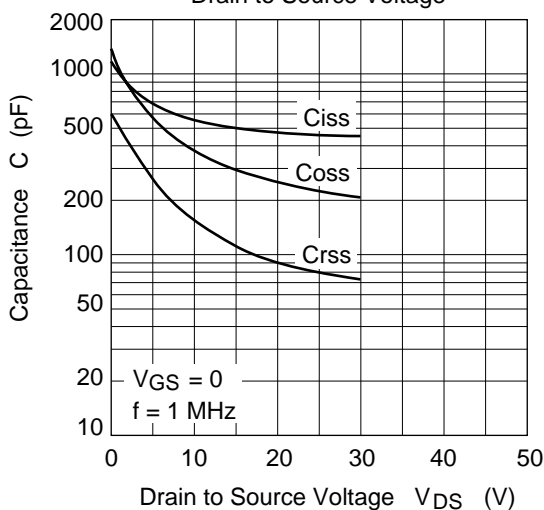




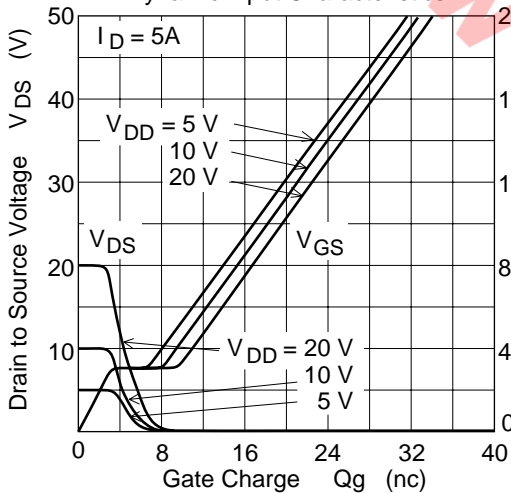
Body to Drain Diode Reverse Recovery Time



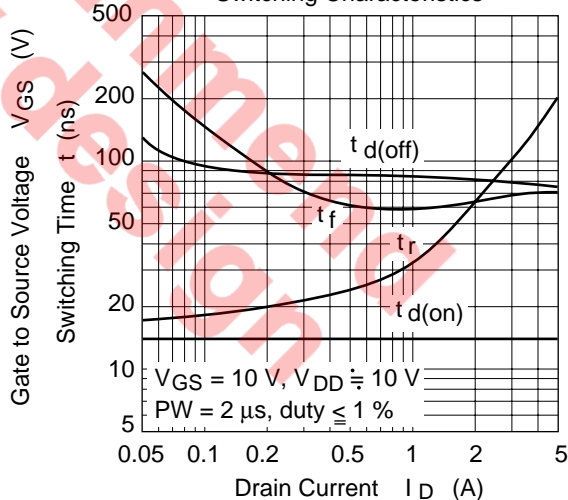
Typical Capacitance vs. Drain to Source Voltage

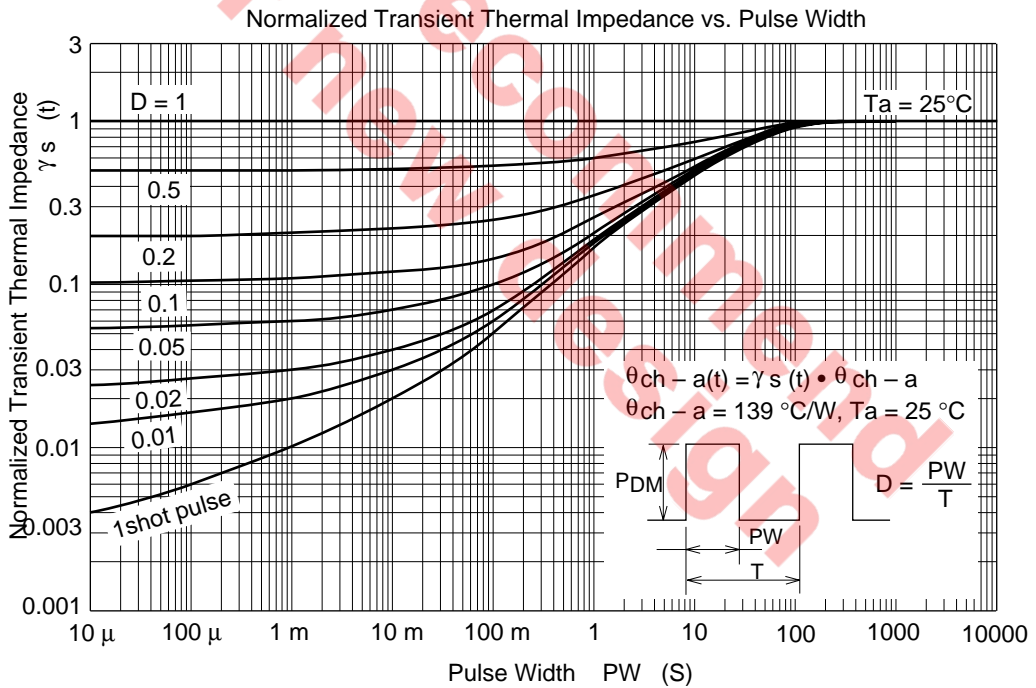
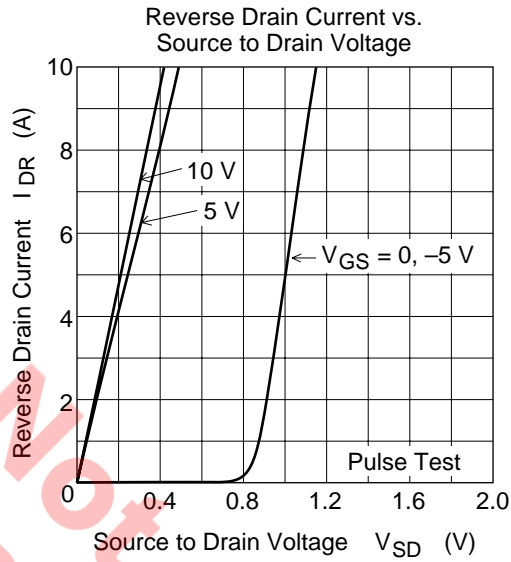


Dynamic Input Characteristics

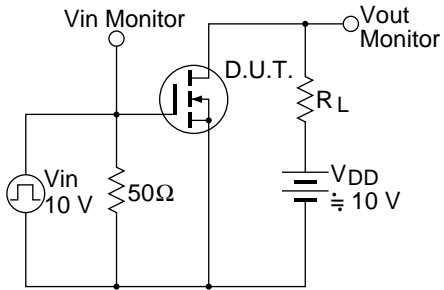


Switching Characteristics

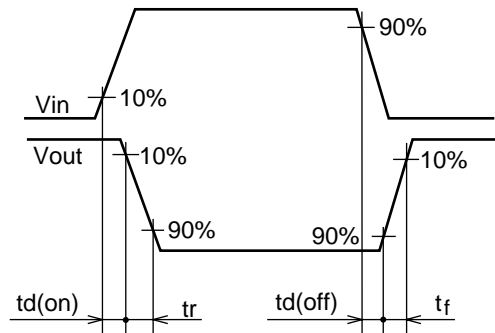




Switching Time Test Circuit



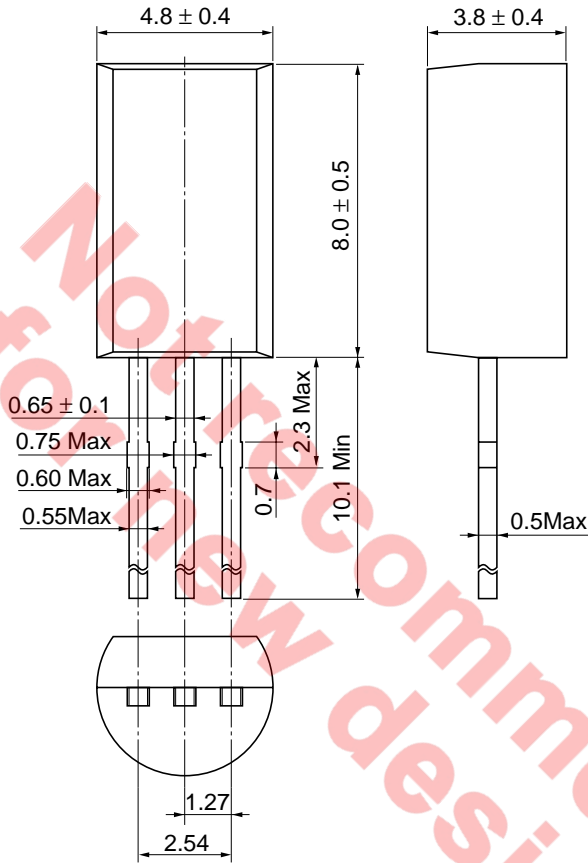
Switching Time Waveforms



Not recommend
for new design

Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	TO-92 Mod
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.35 g

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